

# **HPA150R**

# **Ultrahigh-Definition CRT Display Horizontal Deflection Output Applications**

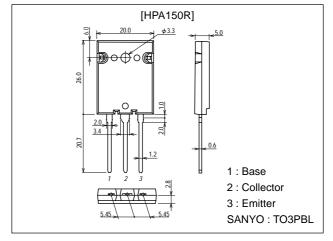
#### **Features**

- · High speed ( $t_f$  typ=100ns).
- · High breakdown voltage (V<sub>CBO</sub>=1500V).
- $\cdot$  High-speed damper diode placed in one package (tfr=0.2  $\mu s$  max).
- · Adoption of MBIT process.
- · High reliability (adoption of HVP process).

## **Package Dimensions**

unit:mm

2048B



## **Specifications**

#### Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V <sub>CBO</sub>		1500	V
Collector-to-Emitter Voltage	VCEO		800	V
Emitter-to-Base Voltage	V <sub>EBO</sub>		6	V
Collector Current	l <sub>C</sub>		15	Α
Collector Current (Pulse)	I <sub>CP</sub>		35	Α
Diode Forward Current	Io		10	Α
Diode Forward Current (Pulse)	l <sub>OP</sub>	PW≤100μs, duty≤50%	15	Α
Total Power Dissipation	PT	Tc=25°C	180	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta = 25°C

Parameter	Symbol	Conditions	Ratings			Unit
	Symbol		min	typ	max	Offic
Collector Cutoff Current	I <sub>CBO</sub>	V <sub>CB</sub> =1500V, I <sub>E</sub> =0			5	mA
Collector Sustain Voltage	V <sub>CEO(sus)</sub>	I <sub>C</sub> =100mA, I <sub>B</sub> =0	800			V
Emitter Cutoff Current	I <sub>EBO</sub>	V <sub>EB</sub> =4V, I <sub>C</sub> =0			1.0	mA
Collector-to-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =10A, I <sub>B</sub> =2.5A			5	V
Base-to-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =10A, I <sub>B</sub> =2.5A			1.5	V

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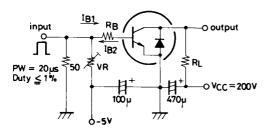
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Parameter	Symbol	Conditions	Ratings			Unit
	Symbol		min	typ	max	Olill
DC Current Gain	h <sub>FE</sub> (1)	V <sub>CE</sub> =5V, I <sub>C</sub> =1.0A				
DC Current Gain	h <sub>FE</sub> (2)	V <sub>CE</sub> =5V, I <sub>C</sub> =10A	4*		10*	
Storage Time	t <sub>stg</sub>	I <sub>C</sub> =8A, I <sub>B1</sub> =1.6A, I <sub>B2</sub> =-3.2A			3.0	μs
Fall Time	t <sub>f</sub>	I <sub>C</sub> =8A, I <sub>B1</sub> =1.6A, I <sub>B2</sub> =-3.2A		0.1	0.2	μs
Diode Forward Voltage	V <sub>F</sub> (1)	I <sub>F</sub> =10A			3	V
Diode Forward Voltage	V <sub>F</sub> (2)	I <sub>F</sub> =15A			5	V
Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =-I <sub>R</sub> =100mA			1	μs
Diode Forward Recovery Time	t <sub>fr</sub>	I <sub>F</sub> =100mA		0.1	0.2	μs

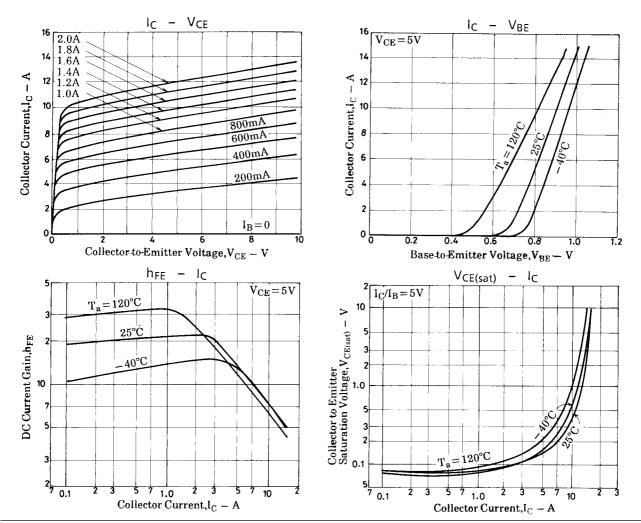
<sup>\*</sup> The HPA150R is classified by 10A  $h_{\mbox{\scriptsize FE}}$  as follows :

hFE	4 to 6	5 to 8	7 to 10	
Rank	Rank 2		4	

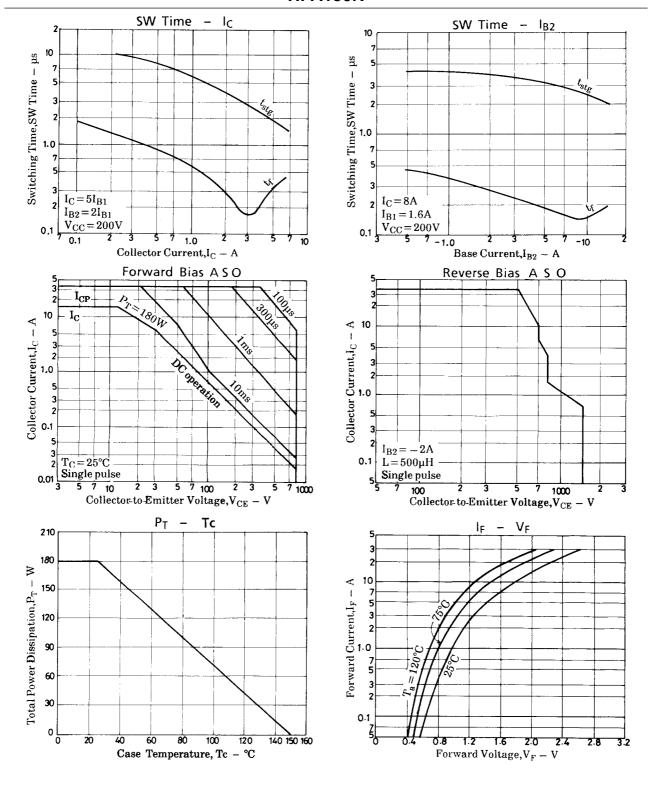
#### **Switching Time Test Circuit**



Unit (resistance: $\Omega$ , capacitance:F)



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